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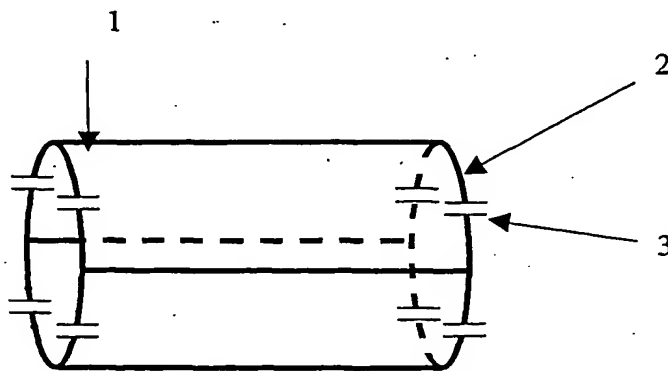
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(54) Title: A HIGH DENSITY PLASMA REACTOR



(57) Abstract: The high density RF plasma source of this invention uses a special antenna configuration to launch waves at frequency such as 13,56MHz. The tunability of this antenna allows to adapt actively the coupling of the RF energy into an evolutive plasma as found in plasma processings in semiconductor manufacturing. This plasma source can be used for the following applications : plasma etching, deposition, sputtering systems, space propulsion, plasma - based sterilization , plasma abatement systems. In another embodiment, the plasma source is in conjunction with one or several process chambers , which comprise an array of magnets and RF coils too . These elements can be used, on one hand, for plasma confinement or the active plasma control (Plasma rotation) thanks to feedback control approach , and one the other hand, for

in situ NMR Monitoring or analysis such as moisture monitoring inside a process chamber , before or after the plasma process, or for in situ NMR Inspection of wafers or others workpieces.

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A HIGH DENSITY PLASMA REACTOR

FIELD OF THE INVENTION

5 The present invention relates to a method and apparatus for enhancing plasma source and associated processes.

BACKGROUND OF THE INVENTION

Helicon wave discharges are known to efficiently produce high-density plasma, and
10 have been exploited as a high density plasma tool for semiconductor processing (etching, deposition, sputtering...) [Lieberman M.A., Lichtenberg A.J., Principles of Plasma Discharges and Materials Processing, J. Wiley & Sons, 1994, New York.], space propulsion and basic plasma experiments. The plasma is usually generated in a cylindrical vacuum vessel in a longitudinal homogeneous magnetic field at 100 – 300 G or higher. The
15 electromagnetic energy is transferred to the plasma source with frequencies between 1 and 50 MHz, usually with 13.56 MHz for processing plasmas. Helicon waves are generated in the plasma column by specially-shaped antennas.

The most common antenna used to excite helicon waves is the Nagoya Type III antenna [Okamura S, et al. 1986 Nucl. Fusion 26 1491], a modification of which is the
20 double-saddle coil of Boswell [Boswell R.W. 1984, Plasma Phys. Control. Fusion, 26 1147]. Helical antennae were first used by Shoji et al., and have been adapted such that single-loop antennae [Sakawa Y., Koshikawa N, Shoji T, 1996 Appl. Phys. Lett. 69 1695 ; Carter C. and Khachan J., 1999 Plasma Sources Sci. Technol. 8 432], double loop antennae [Tynan G.R. et al. 1997 J. Vac. Sci. Technol. A 15 2885 ; Degeling A.W., Jung C.O., Boswell R.W.,
25 Ellingboe A.R., 1996 Phys. Plasmas 3 2788], solenoid antennae [Kim J.H., Yun S.M., and Chang H.Y. 1996 Phys. Lett. A 221 94], and bifilar rotating-field antennae [Miljak D.G. and Chen F.F. 1998 Plasma Sources Sci. Technol. 7 61].

The damping of this wave can be explained by collisional theory [Chen F.F., Sudit I.D. and Light M., 1996 Plasma Sources Sci. Technol. 5 173], but collisionless (Landau)
30 damping of helicon waves and the helicon wave transfer through the excitation of another wave at the boundary of the chamber called Trivelpiece-Gould mode has also been discussed [Chen F.F. Physical mechanisms in industrial RF plasma Sources, LTP-104, 2001, UCLA]. The type of discharge achieves electron densities up to $10^{12} - 10^{13} \text{ cm}^{-3}$ in the 0.1 Pa pressure range.

The main features which define the right antenna structure to excite Helicon waves for generation of plasmas are :

- Frequency of Excitation : It should be such that the waves satisfies : $\omega_{ci} < \omega < \omega_{ce}$ (ω_{ci} = ion cyclotron frequency , ω_{ce} = electron cyclotron frequency). Industrial standard
5 frequency such as 13.56MHz are usually used in semiconductor processing.

- Wave mode : the mode structure of the wave electromagnetic fields generated so that an antenna arrangement can best be designed to efficiently couple the RF power into wave excitation. The two lowest modes are $m=0$ and $m=1$ modes. The best way to excite the mode $m=0$ would be with two loops separated in distance by a half-wavelength. For the mode $m=1$
10 there is a natural helical pitch to the electric and magnetic field vectors as the wave propagates along a principal axis. Given the state of the art, the current way to excite this mode is with a helical shaped antenna.

- Efficiency of coupling RF power to plasma : the efficiency of the plasma production depends on the coupling of RF energy into the plasma. An important mechanism for damping
15 of the RF energy is Landau damping. The phase velocity of the helicon wave is given by ω/k_z , where k_z is given by the dispersion relation and depends on the plasma density and magnetic field strength. Ideally, the phase velocity of the wave should be near the maximum of the ionisation potential of the gas we wish to ionise. The higher the value of k_z , the higher the density. But if k_z is too high then the energy of the electrons may fall below the ionisation
20 potential. It is therefore important to control k_z in order to be able to increase the density and control the electron temperature.

It is known to generate Helicon waves with an apparatus comprises four pairs of electrodes (US patent N°5 146 137, K-H Kretschmer & al.,1992-09-08) . A first pair of the
25 electrodes is connected to a first voltage. A second pair of the electrodes is connected to a second voltage. The first voltage is 90.degree. phase shifted relative to the second voltage. The first and second pairs of electrodes are mounted on a first region of the container. The third pair of the electrodes and the fourth pair of the electrodes are then mounted on a second region of the container a distance from the first region of the container. The third and fourth
30 pair of electrodes are connected to phase shifted voltages, in a manner similar to the first and second pair of electrodes. In an alternate aspect, the apparatus generate a plasma inside a container using circularly polarized waves by coupling electromagnetic energy into the plasma through the container wall from the outside : The apparatus comprises four coils. A

first coil is connected to a first voltage. A second coil is connected to a second voltage. The first voltage is 90.degree. phase shifted relative to the second voltage. The third and fourth coil are connected to phase shifted voltages, in a manner similar to the first and second coil. In yet a third form, the apparatus comprises four pairs of coils. A first pair of the coils is
5 connected to a first voltage. A second pair of the coils is connected to a second voltage. The first voltage is 90.degree. phase shifted relative to the second voltage. The first and second pairs of coils are mounted on a first region of the container. The third pair of the coils and the fourth pair of the coils are then mounted on a second region of the container a distance from the first region of the container. The third and fourth pair of coils are connected to phase
10 shifted voltages, in a manner similar to the first and second pairs of coils.

The major differences between the previous apparatus and our invention is that our antenna consists in one coil (conductive loop and axial segments are connected) including capacitive elements whereas the apparatus consists in four independent electrodes or coils without connected capacitive elements. Moreover, our invention is a resonant antenna where
15 there is a sinusoidal current distribution in function of the azimuthal angle which is not the case for the apparatus.

The conjunction of the plasma source with a process chamber where workpieces are
20 located to either deposit, or etch films or to sputter deposit films to the workpieces is known. This processing system comprises, in particular, external magnet components and RF coils in order to be used as an in situ Nuclear Magnetic Resonance. The use of nuclear magnetic resonance (NMR) for physical , chemical and biological studies is very well developed and highly successful [P.J. Hore, Nuclear Magnetic Resonance, Oxford University Press, Oxford,
25 UK, 1995]. The application of NMR for Plasma diagnostic techniques has recently been undertaken [Zweben S.J. et al., 2003, Rev. Sci. Inst., 74, 1460] for Tokamak experiments. The application of NMR in low pressure and/or temperature plasma processes in particular for moisture monitoring, contamination monitoring, chamber characterizations , in order to reduce the troubleshooting time of the equipment and improve the quality of manufactured
30 devices, is still quite innovative.

SUMMARY OF THE INVENTION

In accordance with the invention, there is provided a plasma source apparatus as defined in claim 1.

5 The invention uses one or multiple plasma source in conjunction with one or multiple process chamber to provide a high and uniform density over a large area inside the process chamber.

In another embodiment, the capacitive elements and/or moveable axial conductive elements of the antenna are tuned such that to increase the coupling between the RF energy and the plasma, defining an active antenna.

10 In another embodiment, the main components in the plasma source or in a process chamber can be used as an in situ monitoring of the environment inside the chamber or an in situ inspection of workpieces (such as wafer as part of semiconductor processes) based on the NMR principle.

15 BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic view of an antenna arrangement according to the present invention

FIG. 2 is a schematic view of an antenna configuration in an another embodiment

FIG. 3 is a schematic view of the basic configuration of a plasma source

20 FIG. 4 is a schematic view of an antenna configuration where axial conductive elements are twisted

FIG. 5 is a schematic view of a configuration of a plasma reactor comprising antennae inside and outside the reactor, and an array of elementary magnets.

FIG. 6 is a schematic view of an antenna arrangement according to the present invention, with opened conductive loops

25 FIG. 7 is a schematic view of an antenna configuration in an another embodiment

FIG. 8 is a schematic view of a network of antennas according to the present invention

DEFINITIONS

30 Fluid : the term comprises gas, diphasic liquids , or supercritical gas

A Conductive loop : a conductive element which can be closed or opened, and which the shape can be circular, or elliptic, or with right angles.

A radio frequency generator : A device supplying continuous or pulsed RF power at one or several frequencies.

A process chamber : a chamber where happen plasma processings such as etching, deposition, sputtering, ion generation, sterilization or a chamber where inside one or several workpieces (wafer(s)) is placed for transfer, conditioning, stock processings.

DETAILED DESCRIPTION

As can be seen on figures 1 , 2, 4, 6 and 7, the first principle structure of the present invention is the antenna configuration :

10 RF current is made to flow through at least a pair of conductive loops (with any topology) 2 and axial conductive elements 1. In such a way that the current is passing in the case of the Figure 2 configuration according to 5. The RF voltage is applied from a RF power supply 4.

One feature of the coil concerns the excitation . Excitation of the RF coil at a single excitation point results in a linearly polarized magnetic field B. Quadrature excitation can be
15 achieved in a straight forward manner using the coil described in one possible configuration (see Figure 1). This can be accomplished by exciting the coil at two input capacitors 3 located at right angles relative to one another along the circumference of one conductive loop elements 2. Additionally, to achieve the desired circular polarization, the RF sources used to excite the coil at two points must be electrically 90 degree out of phase relative to one
20 another. In this manner, the two modes with approximately uniform transverse fields , as described above are excited.

A further feature of the antenna can be realized by utilizing multiple RF amplifiers to energize the antenna. Each amplifier is attached to different input capacitor, and the signal through each amplifier is phased correctly to produce the desired RF excitation. In this way,
25 the power requirement from each amplifier is reduced as compared to the requirement for driving the antenna with one or two amplifiers.

The antenna can be made with a solid round wire , in copper for example , or with a conductor consisting of a number of separately insulated strands that are twisted or braided together. Since each strand tends to take all possible positions in the cross section of the entire
30 conductor, this design equalizes the flux linkages – and reactances – of the individual strands causing the current to spread uniformly throughout the conductor. The primary benefit is the reduction of AC losses. An example of such construction are known as Litz wire.

It should be recognized that the multiple amplifier configurations described above are merely exemplary and many other combinations utilizing four or more amplifiers are possible.

5 A basic configuration of the plasma source is shown on the Figure 3. with a Pyrex plasma generation chamber 6 surrounded by magnet field generators 8 placed on a pipe typically in PVC. The RF power 10 gives energy to the antenna through a matching network 9.

10 A major advantage of this antenna is that the current distribution appears to be zero for every mode $m \neq \pm 1$. All the antenna power will be concentrated in those two modes. Experimentally the $m=1$ mode appears to be the more efficient for plasma heating with helicon waves. Another advantage is the high homogeneity of the plasma inside the chamber which can decrease significantly the damage on integrated circuits, increasing the yield of the
15 manufacturing.

Especially in processing plasmas , the main features (density, electron temperature, ionic temperature, partial pressure species...) are dependent of the process time due to the interactions not only with the workpieces but also with the whole process chamber. That is
20 why the possibility to adjust the coupling between the RF energy and the evolutive plasma allows high improvements of the process and the uptime of the equipment. We propose in another embodiment according the present invention to define an Active Antenna : where at least one capacitor is tunable and / or at least one conductive loop position is moveable , and / or at least one conductive loop rotation (\rightarrow twisted antenna) leading to a non zero angle
25 between the axial conductive element's connexion on the first upper loop and the axial conductive element's connexion on the first lower loop, is moveable. A further configuration involves the feedback control of the active antenna according to sensors used as diagnostic techniques (magnetic probe, optical probe, Langmuir probe, Hall probe...).

30 In another embodiment according to the present invention, the magnets can deliver magnetic amplitudes in function of time and/or space to perform peristaltic magnetic actions on the plasma defining in the plasma generation chamber successive areas of high and low density. This pattern can generate multiple double layers which are structures constituted by

two adjacent sheaths of charge with opposite signs connecting different values of plasma potential through a monotonic spatial potential profile.

In another embodiment according to the present invention, in order to enhance the performances of the plasma source it is possible to add close to the source a complementary source as Electron cyclotron resonance, ion cyclotron resonance or Electron Bernstein wave.

In another embodiment according to the present invention where frequency tuning is accomplished by mechanically moving a concentric RF shield about the longitudinal axis of an RF coil. Moving the shield about the RF coil effectively changes the mutual inductance of the system, providing a mechanism for adjusting the resonant frequency.

In another embodiment according to the present invention the plasma source is in conjunction with a process chamber (see Figure 5) comprising an array of magnets 14, an array of RF coils outside the chamber walls 15, and an array of RF coils inside the chamber 16. The RF coils can be design as the one of the plasma source, that is to say with a plurality of capacitors. One part of the coils are used as feedback coils and the other part as sensor coils. It is possible to control the plasma stability by acquiring the coil sensor signal and, after treatment, to apply convenient current in order to improve the plasma behaviour. The sensors coils can be replaced by other type of sensors (optical probe, Hall probe,...).

In another embodiment according to the present invention, series of electrodes are added inside the process chamber on which typically an oscillating voltage. This action allows to confine the plasma and / or particles. The quadrupole electric fields of this trap exert radial forces on the charged particles that are analogous to radial forces that a periodic focusing quadrupole magnetic field exerts on charged particles.

In another embodiment according the present invention, we use the components of the process chamber (array of magnets and arrays of RF coils) to proceed to an in situ monitoring by Nuclear Magnetic Resonance. Indeed, we can apply a transient pulse of RF field through one or more coils. After tuning off the pulse(s), the emitted energy is measured as an alternating voltage induced in the same coil(s). The amplitude of this NMR signal is proportional to number of resonant spins in the observed object (Chamber wall, workpieces ...). But the absorbed excess energy is also dissipated due to interactions between the spins and their atomic and molecular environment as well as due to spin-spin interactions. These

interactions are modulated in time by molecular motions giving rise to two relaxation processes. It leads for example that chemically combined water can be distinguished from water, which is physically bound to a solid surface and water, which is in the bulk liquid state. It is possible to improve the monitoring by a magnetic field strength, which defines a gradient
5 in a specific direction.

These NMR monitoring allow to improve significantly the process (before and after the plasma process, or after a preventive maintenance, it is possible to control the quality of the atmosphere, in particular the water rate), to optimise the uptime of the equipment and then the yield of the manufactured devices.

10 In another embodiment according to the present invention, the plasma source is coupled with an optical resonator to carry out a gas laser system by RF plasma. This device comprises a gas discharge tube made of quartz and sealed with two flat semi-transparent mirrors defining an optical resonator, the antenna of the present invention used in the
15 presence of magnets to excite RF discharge. One of the mirrors can be mounted on a piezoelectric transducer. The mirrors are aligned to provide multiple reflections of lightwaves.

In another embodiment according to the present invention, the plasma source is couple with an apparatus generating acoustic cavitation bubbles, which act as nuclei for the ignition
20 and maintenance of the plasma. Because the plasma is formed in a liquid environment, it is possible to obtain much higher film deposition rates or etching rates (it depends on chemical species involved) at much lower plasma temperatures than ever before. In addition this process can be carried out at normal temperatures and pressures. Previous combinations of ultrasonic waves and on one hand, microwave irradiation was performed by S.Nomura and H.
25 Toyota, 2003, Applied Physics Letters, 83, 4503, and one the other hand, glow discharge engineered by Dow Corning Plasma. Here we propose to combine the ultrasonic waves with a RF plasma type.

The main applications where the present invention is relevant are : plasma processing
30 (semiconductor manufacturing , Microtechnologies , nanotechnologies) , Plasma welding, plasma-based sterilization, Plasma cutting, space propulsion, plasma abatment systems, academic research....

Although the invention has been described and illustrated with particularity, it is intended to be illustrative of preferred embodiments. It is understood that the disclosure has been made by way of example only. Numerous changes in the combination and arrangements of the parts, steps and features can be made by those skilled in the art without departing from
5 the spirit and scope of the invention, as hereinafter claimed.

CLAIMS

1. A plasma source apparatus, comprising :
- 5 a. an antenna,
 b. a plasma generation chamber in the proximity of the antenna,
 c. a fluid injector for introducing at least one fluid into the plasma generation chamber,
 d. a radio frequency generator with continuous or pulsed RF power supply
- 10 characterized by the fact that said antenna comprises two conductive loop elements spaced along a common longitudinal axis and at least one axial conductive segment electrically interconnecting said conductive loop elements, each of said conductive loop elements and/or said axial conductive segment including at least one capacitive element.
- 15
2. Plasma source apparatus according to claim 1 wherein only said conductive loop elements include at least one capacitive element.
3. Plasma source apparatus according to claim 1 wherein only said axial conductive element includes at least one capacitive element.
- 20
4. Plasma source apparatus according to claim 1 wherein said conductive loop elements and said axial conductive segment include at least one capacitive element.
- 25
5. Plasma source apparatus according to anyone of the previous claims comprising several axial conductive segments, each axial conductive segment interconnecting said conductive loop elements.
- 30
6. Plasma source apparatus according to anyone of the previous claims comprising antenna cooling means such as a chiller , a heat pipe , a Cryo-cooler or a Peltier device.

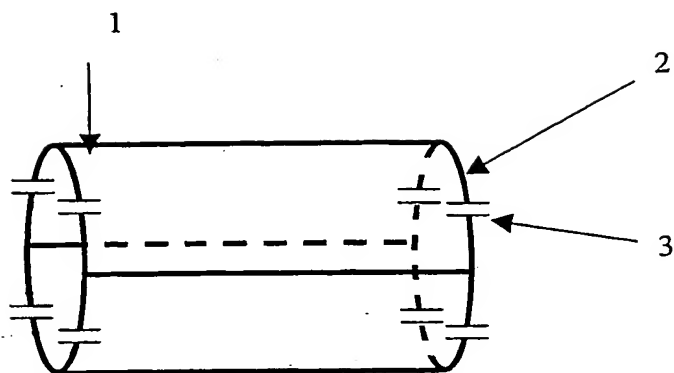
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7. Plasma source apparatus according to anyone of the previous claims comprising thermal control means of the plasma generation chamber in order to avoid thermal shock between the inside and the outside of the plasma generation chamber during especially the plasma ignition.
- 10
8. Plasma source apparatus according to anyone of the previous claims comprising a matching network interconnecting the radio frequency generator and the antenna, in such a way as to promote the optimal transfer of radio frequency energy from the radio frequency generator to the antenna.
- 15
9. Plasma source apparatus according to anyone of the previous claims comprising a fixed or a moveable shield, enclosing but disconnected from the antenna which is adapted to define or to adjust in real time the optimal electromagnetic coupling between the antenna and the plasma.
- 20
10. Plasma source apparatus according to the previous claim wherein the axial conductive element(s) connect(s) directly to the shield through the capacitive element(s).
- 25
11. Plasma source apparatus according to anyone of the previous claims comprising a magnetic field generator arranged around the antenna.
- 30
12. Plasma source apparatus according to anyone of the previous claims wherein at least one of said capacitive element is tunable.
13. Plasma source apparatus according to anyone of the previous claims wherein said axial conductive element or at least one of said axial conductive segments is twisted.
14. Plasma source apparatus according to anyone of the previous claims wherein at least one of said conductive loop elements is movable.
15. Plasma source apparatus according to anyone of the previous claims coupled with an optical resonator comprising at least two mirrors (one partially reflecting) placed at the limits of the plasma generation chamber. The mirrors are aligned to provide multiple reflections of lightwaves.

16. Plasma source apparatus according to anyone of the previous claims coupled with an apparatus generating cavitation bubbles by ultrasonic waves ; the RF energy is then induces into the interior of the acoustic cavitation bubbles which act as nuclei for the ignition and the maintenance of the plasma. The plasma generation chamber can contain the liquid from where the bubbles are generated.
17. Plasma source apparatus according to anyone of the previous claims coupled with a complementary plasma source as Electron cyclotron resonance source or Ion cyclotron resonance source.
18. Plasma source apparatus according to anyone of the previous claims coupled with a complementary antenna inside or outside the plasma generation chamber.
19. Plasma source apparatus according to anyone of the previous claims wherein the antenna is also adapted as a receiving system to perform Nuclear Magnetic Resonance (NMR) Monitoring or analysis of fluid or a workpiece implemented inside the plasma generation chamber.
20. Plasma source apparatus according to anyone of the previous claims wherein each of said axial conductive segment(s) and/or said conductive loop elements are made with volume conductive wire, or braids wire , typically Litz wire, or hollow wire.
21. Plasma source apparatus according to anyone of the previous claims comprising a network of antennas as defined in the previous claims wherein adjacent pairs of conductive loop elements have at least one common axial conductive segment.
22. A plasma source apparatus according to anyone of the previous claims, being connected to one or a plurality of process chamber.
23. A plurality of plasma source apparatuses according to anyone of the previous claims, each plasma sources being cooperatively connected to at least one process chamber.

24. One or a plurality of plasma source apparatuses according to the previous claims comprising a plurality of RF coils , the RF coils being arranged in a circumferential manner proximate to the process chamber(s).
- 5 25. One or a plurality of plasma source apparatuses according to the previous claims wherein at least one RF coils comprises a capacitive element.
26. One or a plurality of plasma source apparatuses according to claim 22, 23,24 or 25 comprising a plurality of magnets , the magnets being arranged in a circumferential
10 manner proximate to the process chamber(s), for exemple, to perform NMR inspection the process chamber and/or the workpiece(s) inside.
27. One or a plurality of plasma source apparatuses according to claim 22, 23, 24,25 or 26 comprising a plurality of electrodes defining a Paul trap type or a Penning trap type on
15 which an oscillating voltage is applied.
28. Use of the plasma source apparatus(es) according to anyone of the previous claims for in situ NMR monitoring of moisture, for example, or the in situ NMR inspection of a process chamber or the in situ NMR analysis of workpieces (e.g. wafers) inside a
20 process chamber.
29. Use of the plasma source apparatus(es) according to anyone of the previous claims wherein the RF excitation is simultaneously applied on one or a plurality ports of the antenna , preferentially, on two ports of the antenna , where the difference between the
25 two ports was a 90° degrees phase shift on the input excitation .

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Fig 1 :



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Fig 2 :

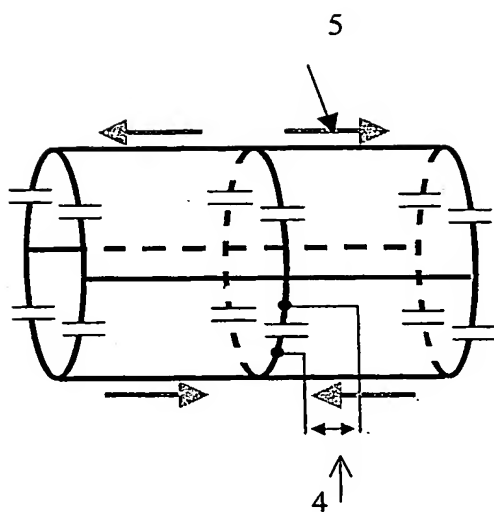
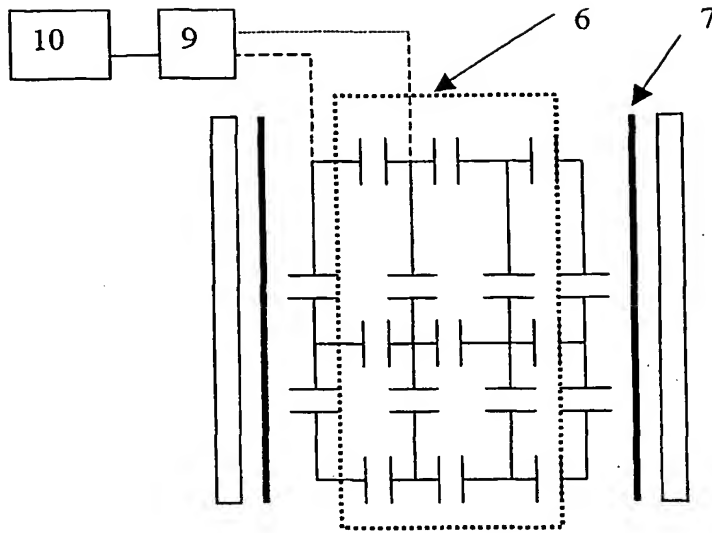


Fig 3 :



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Fig 4 :

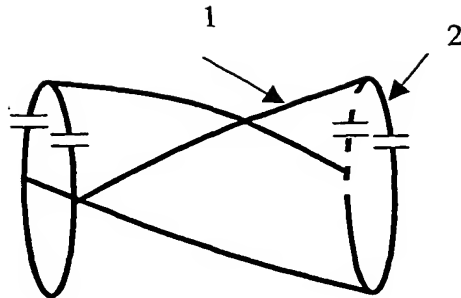


Fig 5 :

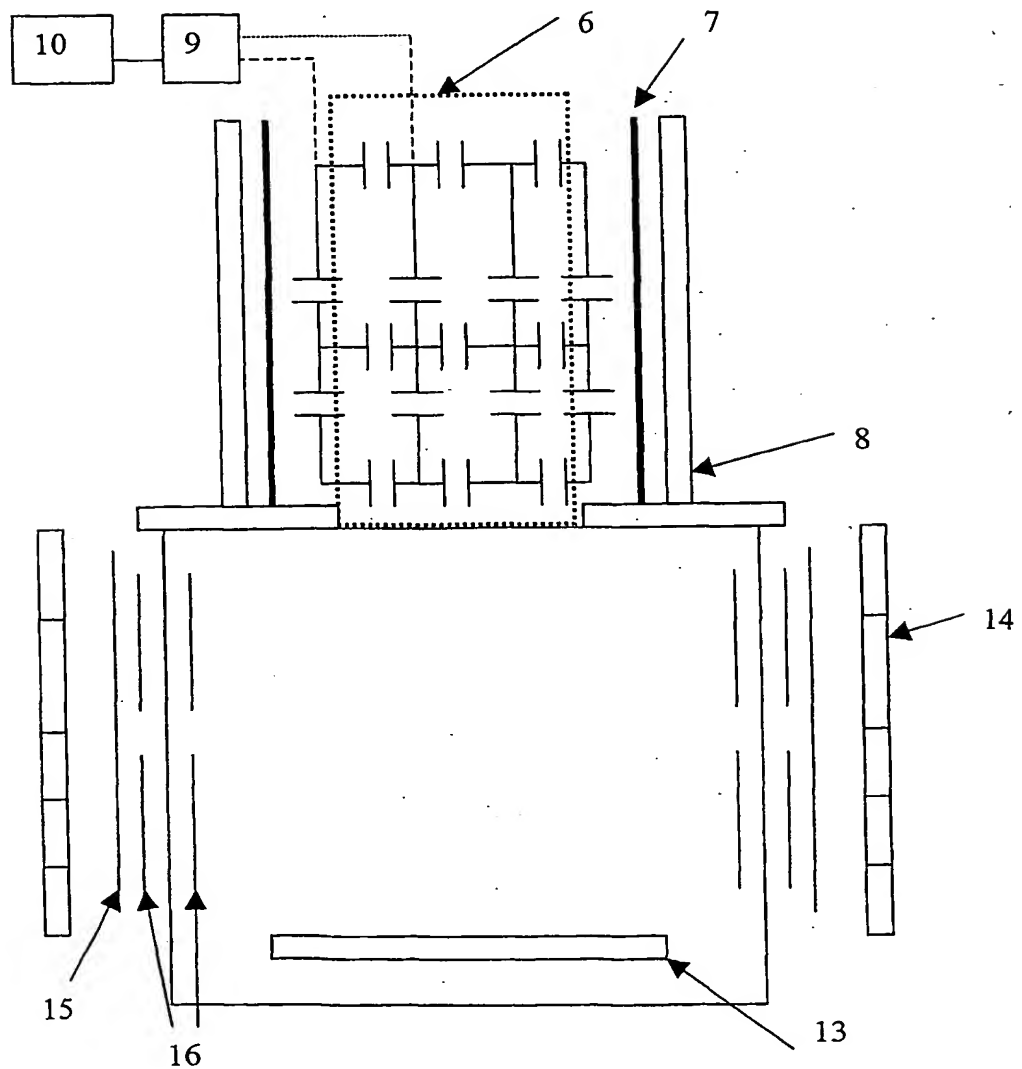


Fig 6

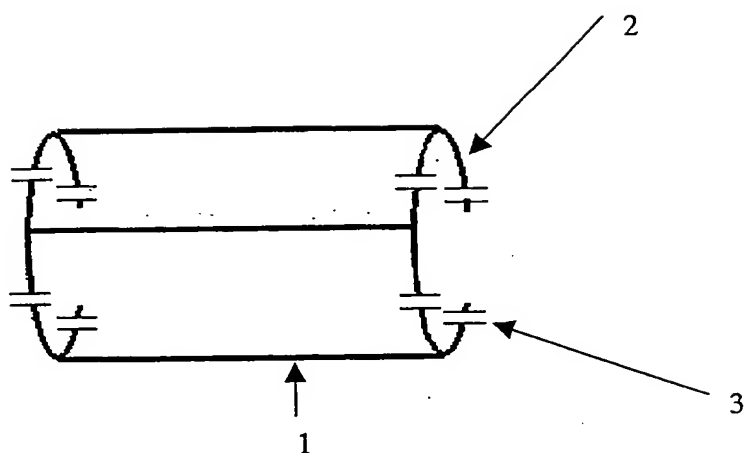
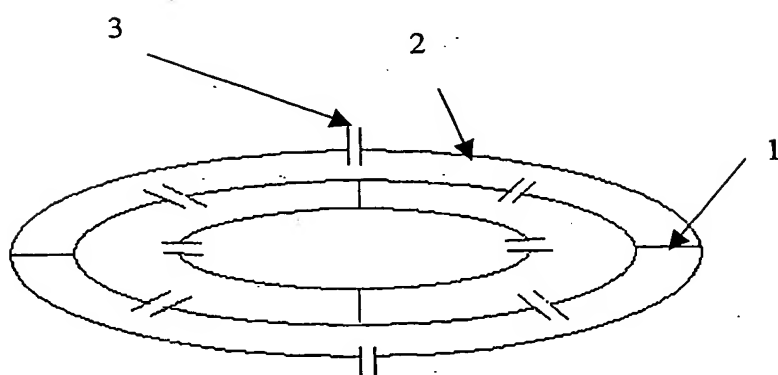
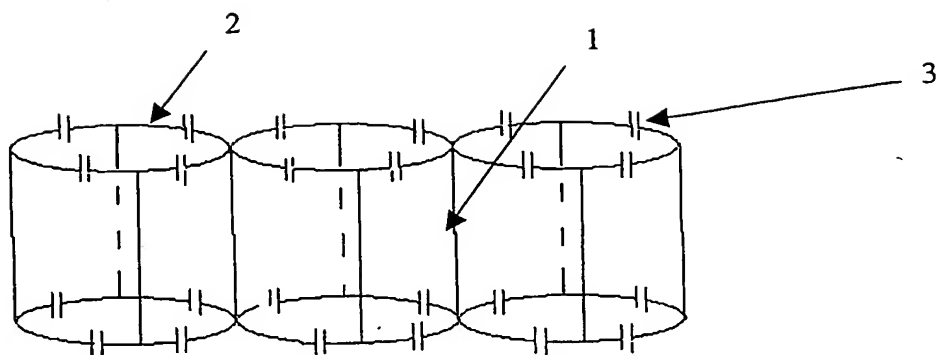


Fig. 7



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Fig. 8



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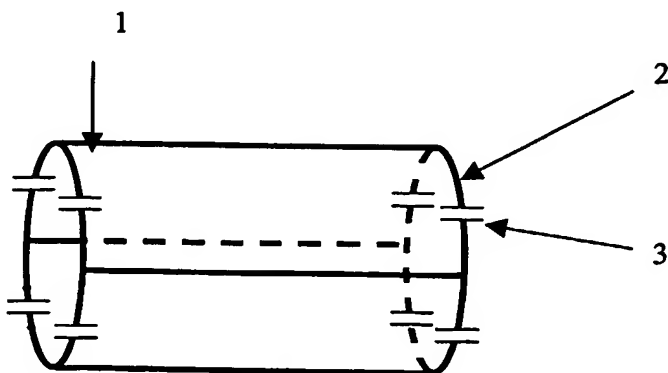
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For two-letter codes and other abbreviations, refer to the "Guid-
ance Notes on Codes and Abbreviations" appearing at the begin-
ning of each regular issue of the PCT Gazette.

(54) Title: A HIGH DENSITY PLASMA REACTOR



(57) Abstract: The high density RF plasma
source of this invention uses a special antenna
configuration to launch waves at frequency such
as 13,56MHz. The antenna comprises several
conductive loops around a common axis and
spaced from each other along the axis. The loops
are electrically connected by axial conductive
segments, and each loop includes a plurality
of serially connected capacitive elements. The
tunability of this antenna allows to adapt actively
the coupling of the RF energy (10) into an
evolutive plasma as found in plasma processings
in semiconductor manufacturing. This plasma
source can be used for the following applications
: plasma etching, deposition, sputtering systems,
space propulsion, plasma - based sterilization
, plasma abatement systems. In another

embodiment, the plasma source is in conjunction with one or several process chambers , which comprise an array of magnets (14)
and RF coils too (15, 16). These elements can be used, on one hand, for plasma confinement or the active plasma control (Plasma
rotation) thanks to feedback control approach , and one the other hand, for in situ NMR Monitoring or analysis such as moisture.

INTERNATIONAL SEARCH REPORT

International Application No
PCT/CH2004/000300

A. CLASSIFICATION OF SUBJECT MATTER
IPC 7 H01J37/32 H05H1/46

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 H01J H05H

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, PAJ, WPI Data, INSPEC, COMPENDEX

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 4 915 978 A (LIEDTKE DIETMAR ET AL) 10 April 1990 (1990-04-10) column 5, line 37 - column 6, line 64; figure 6	1,3-5,8, 12,14, 20-22, 24,25
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☒ Further documents are listed in the continuation of box C.

☒ Patent family members are listed in annex.

* Special categories of cited documents:

- "A" document defining the general state of the art which is not considered to be of particular relevance
- "E" earlier document but published on or after the international filing date
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- "O" document referring to an oral disclosure, use, exhibition or other means
- "P" document published prior to the international filing date but later than the priority date claimed

"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention

"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.

"&" document member of the same patent family

Date of the actual completion of the international search

29 November 2004

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INTERNATIONAL SEARCH REPORT

International Application No
PCT/CH2004/000300

C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category °	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
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Y	column 2, line 16 - column 5, line 36; claim 8; figures 8-11	
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INTERNATIONAL SEARCH REPORT

International application No.
PCT/CH2004/000300

Box II Observations where certain claims were found unsearchable (Continuation of item 2 of first sheet)

This International Search Report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:

1. ☐ Claims Nos.:
because they relate to subject matter not required to be searched by this Authority, namely:
2. ☐ Claims Nos.:
because they relate to parts of the International Application that do not comply with the prescribed requirements to such an extent that no meaningful International Search can be carried out, specifically:
3. ☐ Claims Nos.:
because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).

Box III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

This International Searching Authority found multiple inventions in this international application, as follows:

see additional sheet

1. ☐ As all required additional search fees were timely paid by the applicant, this International Search Report covers all searchable claims.
2. ☐ As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.
3. ☐ As only some of the required additional search fees were timely paid by the applicant, this International Search Report covers only those claims for which fees were paid, specifically claims Nos.:
4. ☒ No required additional search fees were timely paid by the applicant. Consequently, this International Search Report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.:
1-6, 8, 11-14, 20-25, 29

Remark on Protest

- ☐ The additional search fees were accompanied by the applicant's protest.
- ☐ No protest accompanied the payment of additional search fees.

FURTHER INFORMATION CONTINUED FROM PCT/ISA/ 210

This International Searching Authority found multiple (groups of) inventions in this international application, as follows:

1. claims: 1-6; 8,11-14,20-25,29 when dependent on claim 1

A plasma source apparatus, comprising: an antenna, a plasma generation chamber in the proximity of the antenna, a fluid injector for introducing at least one fluid into the plasma generation chamber, a radio frequency generator with continuous or pulsed RF power supply, wherein said antenna comprises two conductive loop elements spaced along a common longitudinal axis and at least one axial conductive segment electrically interconnecting said conductive loop elements, each of said conductive loop elements and/or said axial conductive segment including at least one capacitive element (claim 1);
wherein only said conductive loop elements include at least one capacitive element (claim 2).

- 1.1. claims: 3-6,8,11-14,20-25,29

Further, not necessarily unitary, developments of the apparatus of claim 1.

2. claim: 7

Plasma source apparatus according to claim 1 comprising thermal control means of the plasma generation chamber

3. claims: 9,10

Plasma source apparatus according to claim 1 comprising a fixed or a moveable shield, enclosing but disconnected from the antenna which is adapted to define or to adjust in real time the optimal electromagnetic coupling between the antenna and the plasma

4. claim: 15

Plasma source apparatus according to claim 1 coupled with an optical resonator comprising at least two mirrors (one partially reflecting) placed at the limits of the plasma generation chamber. The mirrors are aligned to provide multiple reflections of lightwaves

5. claim: 16

FURTHER INFORMATION CONTINUED FROM PCT/ISA/ 210

Plasma source apparatus according to claim 1 coupled with an apparatus generating cavitation bubbles by ultrasonic waves; the RF energy is then induces into the interior of the acoustic cavitation bubbles which act as nuclei for the ignition and the maintenance of the plasma. The plasma generation chamber can contain the liquid from where the bubbles are generated.

6. claim: 17

Plasma source apparatus according to claim 1 coupled with a complementary plasma source as Electron cyclotron resonance source or Ion cyclotron resonance source

7. claims: 18,19,26,28

Plasma source apparatus according to claim 1 coupled with a complementary antenna inside or outside the plasma generation chamber (claim 18);
or otherwise adapted for performing NMR monitoring or analysis (claims 19,26,28)

8. claim: 27

One or a plurality of plasma source apparatuses according to claim 22 comprising a plurality of electrodes defining a Paul trap type or a Penning trap type on which an oscillating voltage is applied

INTERNATIONAL SEARCH REPORT

International Application No
PCT/CH2004/000300

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